January 2004

FDS6694

FAIRCHILD SEMICONDUCTOR

30V N-Channel Fast Switching PowerTrench⁰ MOSFET

General Description

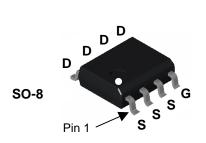
This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $R_{DS(ON)}$ and fast switching speed.

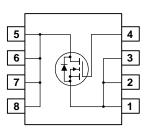
Applications

- DC/DC converter
- Power management
- Load switch

Features

- 12 A, 30 V. $R_{DS(ON)} = 11 \text{ m}\Omega @ V_{GS} = 10 \text{ V}$ $R_{DS(ON)} = 13.5 \text{ m}\Omega @ V_{GS} = 4.5 \text{ V}$
- Low gate charge (13 nC typical)
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- High power and current handling capability.





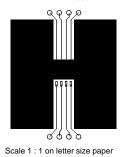
Absolute Maximum Ratings T_{A=25°C} unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		30	V
V _{GSS}	Gate-Source Voltage		±20	V
ID	Drain Current – Continuous	(Note 1a)	12	А
	– Pulsed		50	
P _D	Power Dissipation for Single Operation	(Note 1a)	2.5	W
		(Note 1b)	1.4	
		(Note 1c)	1.2	
T _J , T _{STG}	Operating and Storage Junction Temperatu	ure Range	-55 to +175	°C
Therma	I Characteristics			
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	50	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1c)	125	°C/W
	Thermal Resistance, Junction-to-Case	(Note 1)	25	°C/W

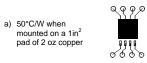
Device Marking	Device	Reel Size	Tape width	Quantity
FDS6694	FDS6694	13"	12mm	2500 units

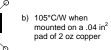
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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics				L	L
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V$, $I_D = 250 \mu A$	30			V
<u>ΔBVdss</u> ΔTj	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25°C		22		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}} = 24 \text{ V}, \qquad V_{\text{GS}} = 0 \text{ V}$			10	μA
I _{GSS}	Gate-Body Leakage	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	1	2	3	V
$\Delta V_{GS(th)}$ ΔT_J	Gate Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, Referenced to 25°C		-5		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance			9.1 11.1 12.2	11 13.5 15	mΩ
I _{D(on)}	On-State Drain Current	$V_{GS} = 10 \text{ V}, \qquad V_{DS} = 5 \text{ V}$	50			Α
g _{FS}	Forward Transconductance	$V_{DS} = 5 V$, $I_{D} = 12 A$		50		S
Dvnamio	c Characteristics					
C _{iss}	Input Capacitance	$V_{DS} = 15 V$, $V_{GS} = 0 V$,		1293		pF
C _{oss}	Output Capacitance	f = 1.0 MHz		342		pF
C _{rss}	Reverse Transfer Capacitance			136		pF
R _G	Gate Resistance			0.84		Ω
Switchir	g Characteristics (Note 2)					
t _{d(on)}	Turn–On Delay Time	$V_{DD} = 15 \text{ V}, \qquad I_D = -1 \text{ A},$		9	18	ns
tr	Turn–On Rise Time	$V_{GS} = 10 \text{ V}, \qquad R_{GEN} = 6 \Omega$		6	12	ns
t _{d(off)}	Turn–Off Delay Time			28	45	ns
t _f	Turn–Off Fall Time			10	20	ns
Qg	Total Gate Charge	$V_{DS} = 15 \text{ V}, \qquad I_D = 12 \text{ A},$		13	19	nC
Q _{gs}	Gate–Source Charge	$V_{GS} = 5 V$		4		nC
Q _{gd}	Gate–Drain Charge			4.7		nC
Drain-S	ource Diode Characteristics	and Maximum Ratings				
ls	Maximum Continuous Drain-Source				2.1	Α
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V, I_S = 2.1 A$ (Note 2)		0.74	1.2	V
t _{rr}	Diode Reverse Recovery Time	$I_F = 12 \text{ A}, d_{iF}/d_t = 100 \text{ A}/\mu \text{s}$		29		nS
Qrr	Diode Reverse Recovery Charge			30		nC



2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%

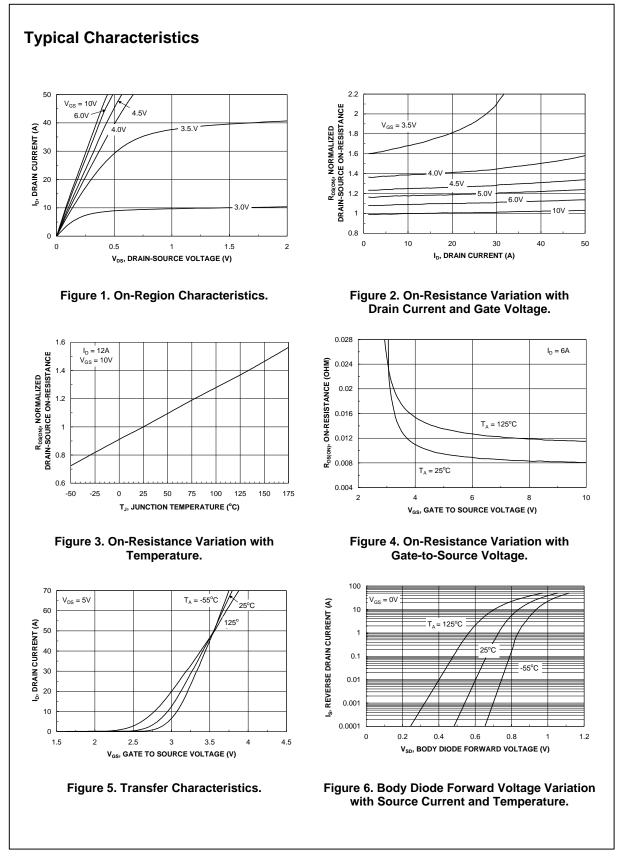




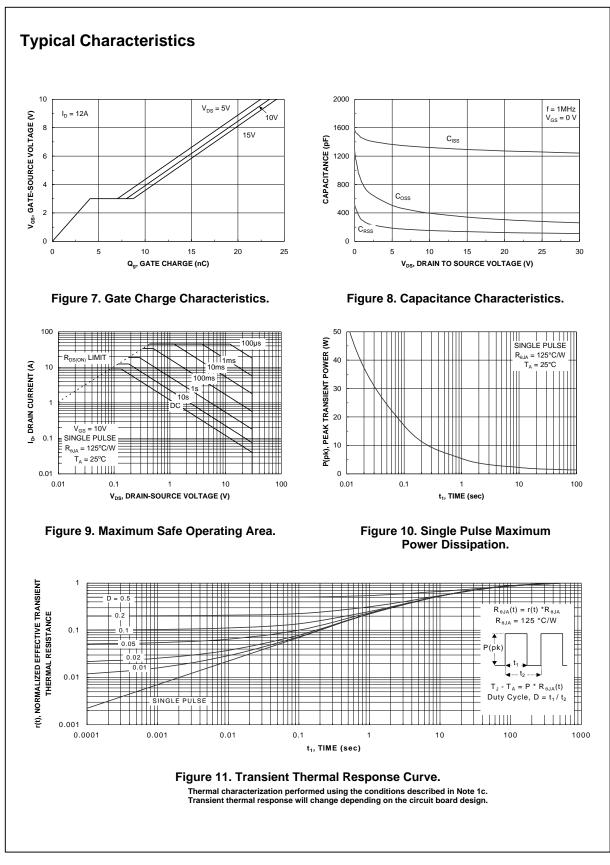
c) 125°C/W when mounted on a minimum pad.

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FDS6694 Rev.E(W)



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